

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JEONGKIL KIM	04/12/2019
MYEONG JUN SHIN	04/12/2019
JANGMO SHIN	04/12/2019
SANGKI LEE	04/12/2019
SEONGHO JEONG	04/12/2019
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<b>Street Address:</b>	128, YEOUI-DAERO, YEONGDEUNGPO-GU
<b>City:</b>	SEOUL
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	07336
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16384330
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<b>NAME OF SUBMITTER:</b>	YONG S. CHOI
<b>SIGNATURE:</b>	/Yong S. Choi/
<b>DATE SIGNED:</b>	04/15/2019
<b>Total Attachments: 2</b>	
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## Assignment of Application

WHEREAS, I (WE)	Jeongkil KIM; Myeong Jun SHIN; Jangmo SHIN; Sangki LEE; Seongho JEONG		
	, respectively.		
have invented certain new and useful improvements in:			
<b>A LATCH MODULE, A HINGE MODULE AND AN APPLIANCE USING THE SAME</b>			
for which an application for Letters Patent was executed on			
(Application No.		, Filed	
), and			
WHEREAS,	<b>LG ELECTRONICS INC.</b>		
(hereinafter referred to as "ASSIGNEE") having a place of business at:			
128, Yeoui-daero, Yeongdeungpo-gu, Seoul 07336, Republic of Korea			

is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;




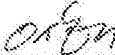
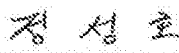
NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and Its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behalf of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and

enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of Dentons US LLP, Attorneys at Law, 1900 K Street, N.W., Washington, D.C. 20006 the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: 12 April 2019	 _____ (Signature of Inventor) Jeongkil KIM
Date: 12 April 2019	 _____ (Signature of Inventor) Myeong Jun SHIN
Date: 12 April 2019	 _____ (Signature of Inventor) Jangmo SHIN
Date: 12 April 2019	 _____ (Signature of Inventor) Sangki LEE
Date: 12 April 2019	 _____ (Signature of Inventor) Seongho JEONG

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